

T7504 and T5504 Quad PCM Codecs with Filters

Features

- 5 V only
- Low-power, latch-up-free CMOS technology
 - 37 mW/channel typical operating power dissipation
 - 1 mW/channel typical powerdown dissipation
- Automatic master clock frequency selection
 - 2.048 MHz or 4.096 MHz
- On-chip sample and hold, autozero, and precision voltage reference
- Differential architecture for high noise immunity and power supply rejection
- Flexible time-slotted PCM interface
 - 2.048 MHz or 4.096 MHz data rate
- Meets or exceeds ITU-T G.711—G.712 requirements and VF characteristics of D3/D4 (as per Legerity PUB 43801)
- Operating temperature range: $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$
- μ -law/A-law companding selectable

Description

The T7504 and T5504 devices are single-chip, four-channel μ -law/A-law PCM codecs with filters. These integrated circuits provide analog-to-digital and digital-to-analog conversion. They provide the transmit and receive filtering necessary to interface a voice telephone circuit to a time-division multiplexed system. These devices are available in 28-pin PLCCs. The T7504 is also available in a 44-pin MQFP.

The T5504 differs from the T7504 in its timing mode. The T5504 operates in the nondelay timing mode (digital data valid when frame sync goes high), and the T7504 operates in the delayed timing mode (digital data is valid one clock cycle after frame sync goes high) (see Figures 6—9).

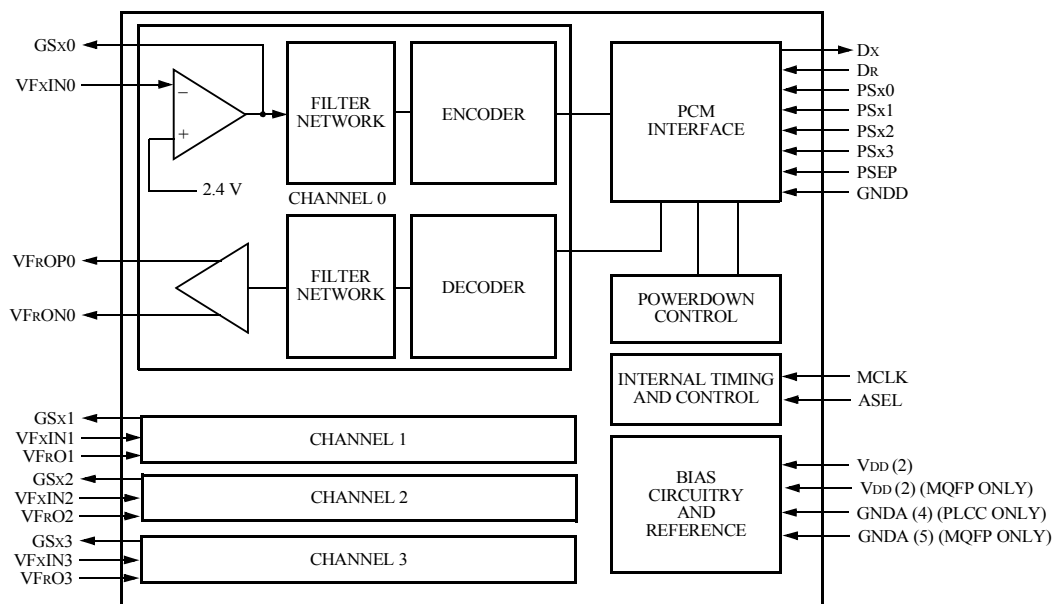


Figure 1. Block Diagram For 28-Pin DIP and 28-Pin PLCC

Functional Description

Four channels of PCM data input and output are passed through only two ports, DX and DR, so some type of time-slot assignment is necessary. The scheme used here is to utilize timing modes of 32 or 64 time slots corresponding to master clock frequencies of either 2.048 MHz or 4.096 MHz, respectively. Each device has four transmit frame sync (FSX) inputs, one for each channel. During a single 125 μs frame, each transmit frame sync input is supplied a single pulse. The timing of the pulse indicates the beginning of the time slot during which the data for that channel is clocked out of the device. During a frame, transmit frame sync pulses must be separated from each other by one or more time slots. A channel is placed in a standby (low-power) mode if its FSX input has been low for 500 μs.

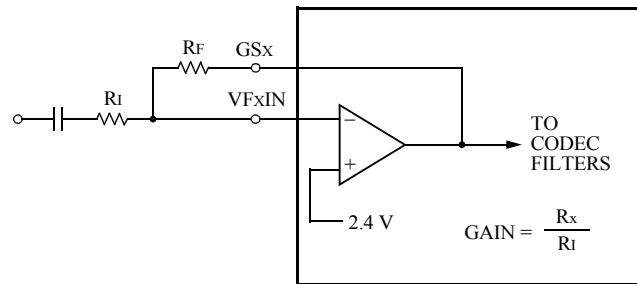
There is a single frame sync separation input (FSEP). The number of negative clock edges minus one that occurs while FSEP is high is the delay (in clock periods) that is placed between the rising edge of a transmit frame sign bit and the falling edge used by the receiver to sample the sign bit. There must always be a pulse on the FSEP input since this input provides the 8 kHz signal required to maintain internal timing. If the FSEP pulse is one clock period or less, the device makes the transmit edges and receive sampling edges one half clock period apart. The entire device is placed in a powerdown mode if FSEP remains low for 500 μs.

Time slot zero is defined as starting on the first rising MCLK edge after FSEP = 1 is detected by a negative MCLK edge. In the T7504, MCLK negative-going edges that detect the start of FSEP and FSxN must be integer multiples of eight MCLK periods apart (zero multiples are allowed). Since FSEP is assumed to define time slot 0, the number of multiples separating FSxN and FSEP is the time-slot number. In the T5504, FSxN for time slot 0 nominally starts on the MCLK positive edge following the negative edge which detects FSEP.

The frequency of the master clock must be either 2.048 MHz or 4.096 MHz. Internal circuitry determines the master clock frequency during the powerup reset interval.

Powerdown is not guaranteed if MCLK is lost unless the device is already in the powerdown mode due to FSEP low for at least 500 μs.

The analog input section in Figure 2 includes an on-chip op amp that is used in conjunction with external, user-supplied resistors to vary encoder passband gain. The feedback resistance (RF) should range from 10 kΩ to 200 kΩ and capacitance from GSx to ground should be kept to less than 50 pF. The input signal at VFXIN should be ac coupled. For best performance, the maximum gain of this op amp should be limited to 20 dB or less.



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Figure 2. Typical Analog Input Section

Pin Information

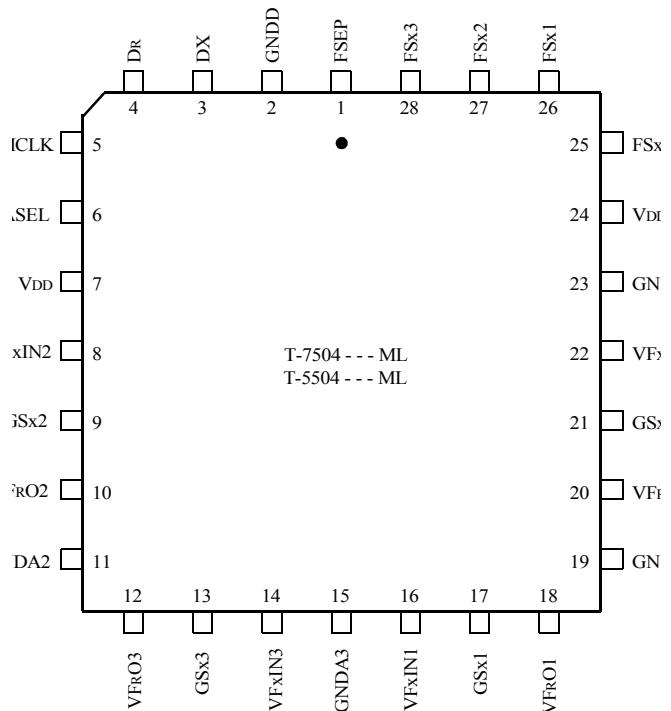
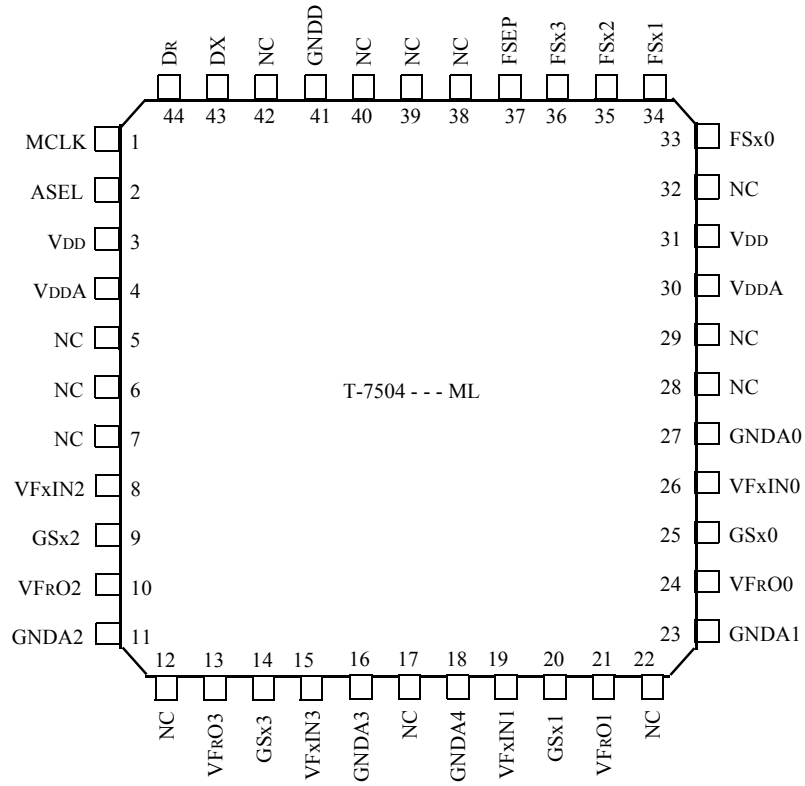


Figure 3. 28-Pin PLCC Pin Diagram



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Figure 4. 44-Pin MQFP Pin Diagram

Pin Information (continued)

Table 1. Pin Descriptions

| Symbol | Pin | | Type* | Name/Function |
|--|---------------------------|----------------------------|----------------|---|
| | PLCC | MQFP | | |
| VFXIN3 VFXIN2 VFXIN1 VFXIN0 | 14 8 16 22 | 15 8 19 26 | I | Voice Frequency Transmitter Input. Analog inverting input to the uncommitted operational amplifier at the transmit filter input. Connect the signal to be digitized to this pin through a resistor R _I (see Figure 2). |
| GSX3 GSX2 GSX1 GSX0 | 13 9 17 21 | 14 9 20 25 | O | Gain Set for Transmitter. Output of the transmit uncommitted operational amplifier. The pin is the input to the transmit differential filters. Connect the pin to its corresponding VFXIN through a resistor R _F (see Figure 2). |
| VFRO3 VFRO2 VFRO1 VFRO0 | 12 10 18 20 | 13 10 21 24 | O | Voice Frequency Receiver Output. This pin can drive 2000 Ω (or greater) loads. |
| VDD [1:0] VDDA [1:0] | 7, 24 — | 3, 31 4, 30 | — | 5 V Digital and Analog Power Supplies. All pins must be connected on the circuit board. Each pin should be bypassed to ground with at least 0.1 μF of capacitance as close to the device as possible. For the DIP and PLCC packages, VDD serves both analog and digital internal circuits. |
| GND A4 GND A3 GND A2 GND A1 GND A0 | — 15 11 19 23 | 18 16 11 23 27 | — | Analog Grounds. All ground pins must be connected on the circuit board. |
| DR | 4 | 44 | I | Receive PCM Data Input. The data on this pin is shifted into the device on the falling edges of MCLK. Data is only entered for valid time slots as defined by the relationship of the pulses on the FSX inputs and the pulse on the FSEP input. |
| DX | 3 | 43 | O | Transmit PCM Data Output. This pin remains in the high-impedance state except during active transmit time slots. An active transmit time slot is defined as one in which a pulse is present on one of the FSx inputs. Data is shifted out on the rising edge of MCLK. |
| MCLK | 5 | 1 | I | Master Clock Input. The frequency must be 2.048 MHz or 4.096 MHz. This clock serves as the bit clock for all PCM data transfer. A 40% to 60% duty cycle is required. |
| GNDD | 2 | 41 | — | Digital Ground. Ground connection for the digital circuitry. All ground pins must be connected on the circuit board. |
| FSX3 FSX2 FSX1 FSX0 | 28 27 26 25 | 36 35 34 33 | I ^d | Transmit Frame Sync. This signal is an edge trigger and must be high for a minimum of one MCLK cycle. This signal must be derived from MCLK. The division ratio is 1:256 or 1:512 (FSX:MCLK). Each FSX input must have a pulse present at the start of the desired active output time slot. Pulses on the various FSX inputs must be separated by one or more integer multiples of time slots. An internal pull-down device is included on each FSX. |
| ASEL | 6 | 2 | I ^d | A-Law/μ-Law Select. A logic low selects μ-law coding. A logic high selects A-law coding. A pull-down device is included. |
| FSEP | 1 | 37 | I | Frame Sync Separation. The pulse width of this 8 kHz signal defines the timing offset between the transmit and receive frames. Internally generated receive frame sync pulses are delayed from the corresponding transmit frame sync pulse rising edge by one less than the FSEP pulse width in negative MCLK edges. If the pulse width is one MCLK period or less, the transmit and receive frame syncs are made coincident. Loss of FSEP causes the device to powerdown. If the master clock frequency is 2.048 MHz or 4.096 MHz, delays of 255 or 511 clock pulses are not allowed, respectively. Timing relationships between FSEP, FSX _N , and time slot 0 are given in Figures 6—9. |

* I^d Indicates a pull-down device is included on this lead.

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the

operational sections of this data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

| Parameter | Symbol | Min | Max | Unit |
|---|------------------|------|-----------------------|------|
| Storage Temperature Range | T _{stg} | -55 | 150 | °C |
| Power Supply Voltage | V _{DD} | — | 6.5 | V |
| Voltage on Any Pin with Respect to Ground | — | -0.5 | 0.5 + V _{DD} | V |
| Maximum Power Dissipation (package limit) | P _D | — | 600 | mW |

Handling Precautions

Although protection circuitry has been designed into this device, proper precautions should be taken to avoid exposure to electrostatic discharge (ESD) during handling and mounting. Legerity employs a human-body model (HBM) and a charged-device model (CDM) for ESD susceptibility testing and protection design evaluation. ESD voltage thresholds are dependent on the circuit parameters used to define the model. No industry-wide standard has been adopted for CDM. However, a standard HBM (resistance = 1500 Ω, capacitance = 100 pF) is widely used and, therefore, can be used for comparison purposes. The HBM ESD threshold presented here was obtained by using these circuit parameters:

| HBM ESD Threshold Voltage | |
|---------------------------|---------|
| Device | Rating |
| T7504 | >2000 V |
| T5504 | >2000 V |

Electrical Characteristics

Specifications apply for T_A = -40 °C to +85 °C, V_{DD} = 5 V ± 5%, MCLK = either 2.048 MHz or 4.096 MHz, and GND = 0 V, unless otherwise noted.

dc Characteristics

Table 2. Digital Interface

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|--|-----------------|---|-----|-----|-----|------|
| Input Low Voltage | V _{IL} | All digital inputs | — | — | 0.8 | V |
| Input High Voltage | V _{IH} | All digital inputs | 2.0 | — | — | V |
| Output Low Voltage | V _{OL} | DX, I _L = 3.2 mA | — | — | 0.4 | V |
| Output High Voltage | V _{OH} | DX, I _L = -3.2 mA | 2.4 | — | — | V |
| | | DX, I _L = -320 μA | 3.5 | — | — | V |
| Input Current, Pins without Pull-down | I _I | Any digital input GND < V _{IN} < V _{DD} | -10 | — | 10 | μA |
| Input Current, Pins with Pull-down | I _I | Any digital input GND < V _{IN} < V _{DD} | — | — | 150 | μA |
| Output Current in High-impedance State | I _{OZ} | DX | -30 | — | 30 | μA |
| Input Capacitance | C _I | — | — | — | 5 | pF |

Electrical Characteristics (continued)**Table 3. Power Dissipation**

Power measurements are made at MCLK = 4.096 MHz, outputs unloaded.

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|-------------------|--------|--|-----|-----|-----|------|
| Powerdown Current | IDD0 | MCLK present, FSx[3:0] = 0.4 V, FSEP = 0.4 V | — | 0.2 | 1 | mA |
| Powerup Current | IDD1 | MCLK, FSx[3:0], FSEP present | — | 30 | 40 | mA |
| Standby Current | IDDS | MCLK, FSEP present; FSx[3:0] = 0.4 V | — | 6 | 10 | mA |

Transmission Characteristics**Table 4. Analog Interface**

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|--|----------------|--|------|------|-------|------------------|
| Input Resistance, VFXIN | RVFXI | 0.25 V < VFXI < 4.75 V | 1.0 | — | — | MΩ |
| Input Leakage Current, VFXIN | IBVFXI | 0.25 V < VFXI < 4.75 V | — | — | 2.4 | μA |
| dc Open-loop Voltage Gain, GSX | AVOL | — | 5000 | — | — | — |
| Open-loop Unity Gain Bandwidth, GSX | f _o | — | 1 | 3 | — | MHz |
| Load Capacitance, GSX | CLX1 | — | — | — | 50 | pF |
| Load Resistance, GSX | RLX1 | — | 10 | — | — | kΩ |
| Input Voltage, VFXIN | VIX | Relative to ground | 2.25 | 2.35 | 2.5 | V |
| Load Resistance, VFRO | RLVFRO | — | 2000 | — | — | Ω |
| Load Capacitance, VFRO | CLVFRO | — | — | — | 100 | pF |
| Output Resistance, VFRO | ROVFRO | 0 dBm0, 1020 Hz PCM code applied to DR | — | — | 20 | Ω |
| | | Partial powerdown FSx = 0 for channel under test | 3000 | — | 10000 | Ω |
| Output Voltage, VFRO | VOR | Alternating ± zero μ-law PCM code applied to DR | 2.25 | 2.35 | 2.5 | V |
| Output Voltage, VFRO, Standby | VORPD | FSx[3:0] = 0.4 V, FSEP = active, no load | 2.15 | 2.4 | 2.65 | V |
| Output Leakage Current, VFRO, Power-down | IOVFRO | FSEP = 0.4 V | -30 | — | 30 | μA |
| Output Voltage Swing, VFRO | VSWR | RL = 2000 Ω | 3.2 | — | — | V _{p-p} |

Transmission Characteristics (continued)

ac Transmission Characteristics

Unless otherwise noted, the analog input is a 0 dBm0, 1020 Hz sine wave; the input amplifier is set for unity gain. The digital input is a PCM bit stream equivalent to that obtained by passing a 0 dBm0, 1020 Hz sine wave through an ideal encoder. The output level is $\sin(x)/x$ -corrected.

Table 5. Absolute Gain

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|--|--------|--|-------|-----|------|------|
| Encoder Milliwatt Response (transmit gain tolerance) | EmW | Signal input of 0.775 Vrms, μ -law or A-law | -0.25 | — | 0.25 | dBm0 |
| Decoder Milliwatt Response (receive gain tolerance) | DmW | Measured relative to 0.775 Vrms, μ -law or A-law, PCM input of 0 dBm0 1020 Hz RL = 10 k Ω | -0.25 | — | 0.25 | dBm0 |

Table 6. Gain Tracking

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|--|--------|----------------------|-------|-----|------|------|
| Transmit Gain Tracking Error Sinusoidal Input μ -Law/A-Law | GTx | +3 dBm0 to -37 dBm0 | -0.25 | — | 0.25 | dB |
| | | -37 dBm0 to -50 dBm0 | -0.50 | — | 0.50 | dB |
| Receive Gain Tracking Error Sinusoidal Input μ -Law/A-Law | GTR | +3 dBm0 to -37 dBm0 | -0.25 | — | 0.25 | dB |
| | | -37 dBm0 to -50 dBm0 | -0.50 | — | 0.50 | dB |

Table 7. Distortion

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---------------------------------------|--------|--|-----|-----|-----|------|
| Transmit Signal to Distortion | SDX | μ -law 3 dBm0 \leq VFxI \leq -30 dBm0 | 36 | — | — | dB |
| | | A-law 3 dBm0 \leq VFxI \leq -30 dBm0 | 35 | — | — | dB |
| | | μ -law -30 dBm0 \leq VFxI \leq -40 dBm0 | 30 | — | — | dB |
| | | A-law -30 dBm0 \leq VFxI \leq -40 dBm0 | 29 | — | — | dB |
| | | μ -law -40 dBm0 \leq VFxI \leq -45 dBm0 | 25 | — | — | dB |
| | | A-law -40 dBm0 \leq VFxI \leq -45 dBm0 | 25 | — | — | dB |
| Receive Signal to Distortion | SDR | μ -law 3 dBm0 \leq VFRO \leq -30 dBm0 | 36 | — | — | dB |
| | | A-law 3 dBm0 \leq VFRO \leq -30 dBm0 | 35 | — | — | dB |
| | | μ -law -30 dBm0 \leq VFRO \leq -40 dBm0 | 30 | — | — | dB |
| | | A-law -30 dBm0 \leq VFRO \leq -40 dBm0 | 29 | — | — | dB |
| | | μ -law -40 dBm0 \leq VFRO \leq -45 dBm0 | 25 | — | — | dB |
| | | A-law -40 dBm0 \leq VFRO \leq -45 dBm0 | 25 | — | — | dB |
| Single Frequency Distortion, Transmit | SFDX | 200 Hz—3400 Hz, 0 dBm0 input, output any other single frequency \leq 3400 Hz | — | — | -38 | dBm0 |
| Single Frequency Distortion, Receive | SFDR | 200 Hz—3400 Hz, 0 dBm0 input, output any other single frequency \leq 3400 Hz | — | — | -40 | dBm0 |
| Intermodulation Distortion | IMD | Transmit or receive, two frequencies in the range (300 Hz—3400 Hz) at -6 dBm0 | — | — | -42 | dBm0 |

Transmission Characteristics (continued)

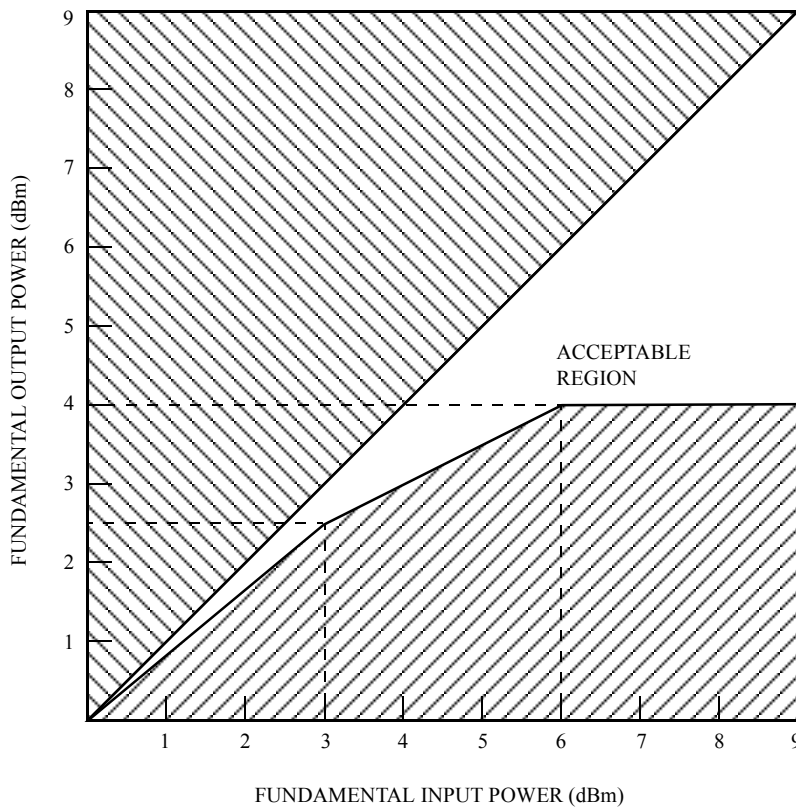
Table 8. Envelope Delay Distortion

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|-------------------------------|--------|---|-----|-----|------------|----------|
| TX Delay, Absolute* | DXA | f = 1600 Hz | — | — | 175 to 425 | μs |
| TX Delay, Relative to 1600 Hz | DXR | f = 500 Hz—600 Hz | — | — | 220 | μs |
| | | f = 600 Hz—800 Hz | — | — | 145 | μs |
| | | f = 800 Hz—1000 Hz | — | — | 75 | μs |
| | | f = 1000 Hz—1600 Hz | — | — | 40 | μs |
| | | f = 1600 Hz—2600 Hz | — | — | 75 | μs |
| | | f = 2600 Hz—2800 Hz f = 2800 Hz—3000 Hz | — | — | 105 155 | μs μs |
| RX Delay, Absolute* | DRA | f = 1600 Hz | — | — | 150 to 405 | μs |
| RX Delay, Relative to 1600 Hz | DRR | f = 500 Hz—1000 Hz | -40 | — | — | μs |
| | | f = 1000 Hz—1600 Hz | -30 | — | — | μs |
| | | f = 1600 Hz—2600 Hz | — | — | 90 | μs |
| | | f = 2600 Hz—2800 Hz | — | — | 125 | μs |
| | | f = 2800 Hz—3000 Hz | — | — | 175 | μs |
| Round Trip Delay, Absolute* | DRTA | Any time slot/channel to any time slot/channel f = 1600 Hz | — | — | 325 to 650 | μs |

* Varies as a function of time slots chosen.

Overload Compression

Figure 5 shows the region of operation for encoder signal levels above the reference input power (0 dBm0).



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Figure 5. Overload Compression

Transmission Characteristics (continued)

Table 9. Noise

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---|--------|---|-----|-----|-----|--------|
| Transmit Noise μ -Law | NXC | — | — | — | 18 | dBrnC0 |
| | | Input amplifier gain = 20 dB | — | — | 19 | dBrnC0 |
| Transmit Noise A-Law | NXP | — | — | — | -68 | dBm0p |
| Receive Noise μ -Law | NRC | PCM code is alternating positive and negative zero | — | — | 13 | dBrnC0 |
| Receive Noise A-Law | NRP | PCM code is A-law positive one | — | — | -75 | dBm0p |
| Noise, Single Frequency $f = 0$ kHz—100 kHz | NRS | VFXIN = 0 Vrms, measurement at VFRO, DR = DX | — | — | -53 | dBm0 |
| Power Supply Rejection Transmit | PSRX | VDD = 5.0 Vdc + 100 mVrms: $f = 0$ kHz—4 kHz | 36 | — | — | dB |
| | | $f = 4$ kHz—50 kHz | 30 | — | — | dB |
| Power Supply Rejection Receive | PSRX | PCM code is positive one LSB VDD = 5.0 Vdc + 100 mVrms: $f = 0$ kHz—4 kHz | 36 | — | — | dB |
| | | $f = 4$ kHz—25 kHz | 40 | — | — | dB |
| | | $f = 25$ kHz—50 kHz | 30 | — | — | dB |
| Spurious Out-of-Band Signals at VFRO Relative to Input | SOS | 0 dBm0, 300 Hz—3400 Hz input PCM code applied: 4600 Hz—7600 Hz | — | — | -30 | dB |
| | | 7600 Hz—8400 Hz | — | — | -40 | dB |
| | | 8400 Hz—50 kHz | — | — | -30 | dB |

Table 10. Receive Gain Relative to Gain at 1.02 kHz

| Frequency (Hz) | Min | Typ | Max | Unit |
|----------------|--------|------------|-------|------|
| Below 3000 | -0.150 | ± 0.04 | 0.150 | dB |
| 3140 | -0.570 | ± 0.04 | 0.150 | dB |
| 3380 | -0.885 | -0.58 | 0.010 | dB |
| 3860 | — | -10.7 | -9.4 | dB |
| 4600 and above | — | — | -28 | dB |

Table 11. Transmit Gain Relative to Gain at 1.02 kHz

| Frequency (Hz) | Min | Typ | Max | Unit |
|----------------|--------|------------|-------|------|
| 16.67 | — | -50 | -30 | dB |
| 40 | — | -34 | -26 | dB |
| 50 | — | -36 | -30 | dB |
| 60 | — | -50 | -30 | dB |
| 200 | -1.8 | -0.5 | 0 | dB |
| 300 to 3000 | -0.150 | ± 0.04 | 0.150 | dB |
| 3140 | -0.570 | ± 0.04 | 0.150 | dB |
| 3380 | -0.885 | -0.58 | 0.010 | dB |
| 3860 | — | -10.7 | -9.4 | dB |
| 4600 and above | — | — | -32 | dB |

Transmission Characteristics (continued)

Table 12. Interchannel Crosstalk (Between Channels) $R_F = \leq 200 \text{ k}\Omega$ (See note below.)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---|---------|---|-----|-----|-----|------|
| Transmit to Receive Crosstalk 0 dBm0 Transmit Levels | CTXX-RY | f = 300 Hz—3400 Hz idle PCM code for channel under test; 0 dBm0 into any other single channel VFXIN | — | -95 | -75 | dB |
| Receive to Transmit Crosstalk 0 dBm0 Receive Levels | CTRX-XY | f = 300 Hz—3400 Hz VFXIN = 0 Vrms for channel under test; 0 dBm0 code level on any other single channel DR | — | -92 | -75 | dB |
| Transmit to Transmit Crosstalk 0 dBm0 Transmit Levels | CTXX-XY | f = 300 Hz—3400 Hz 0 dBm0 applied to any single channel VFXIN except channel under test, which has VFXIN = 0 Vrms | — | -90 | -75 | dB |
| Receive to Receive Crosstalk 0 dBm0 Receive Levels | CTRX-RY | f = 300 Hz—3400 Hz 0 dBm0 code level on any single channel DR except channel under test, which has idle code applied | — | -95 | -75 | dB |

Table 13. Intrachannel Crosstalk (Within Channels) $R_F = \leq 200 \text{ k}\Omega$ (See Note below.)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|--|---------|---|-----|-----|-----|------|
| Transmit to Receive Crosstalk 0 dBm0 Transmit Levels | CTXX-RX | f = 300 Hz—3400 Hz idle PCM code for channel under test; 0 dBm0 into VFXIN | — | -95 | -65 | dB |
| Receive to Transmit Crosstalk 0 dBm0 Receive Levels | CTRX-XX | f = 300 Hz—3400 Hz VFXIN = 0 Vrms for channel under test; 0 dBm0 code level on DR | — | -73 | -65 | dB |

Note: For Tables 11 and 12, crosstalk into the transmit channels (VFXIN) can be significantly affected by parasitic capacitive feeds from GSX and VFRO outputs. PWB layouts should be arranged to keep these parasitics low. The resistor value of R_F (from GSX to VFXIN) should also be kept as low as possible (while maintaining the load on GSX above 10 k Ω per Table 4) to minimize crosstalk.

Timing Characteristics

Table 14. Clock Section (See Figures 6, 7, 8, and 9.)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|------------------------|-----------------------------|-----------------|-----|-----|-----|------|
| tMCHMCL1 | Clock Pulse Width | — | 97 | — | — | ns |
| tCDC | Duty Cycle, MC | — | 40 | — | 60 | % |
| tMCH1MCH2 tMCL2MCL1 | Clock Rise and Fall Time | — | 0 | — | 15 | ns |

Table 15. T7504 Transmit Section (See Figure 6.)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|---------|--------------------------|--------------------|-----|-----|---------------|------|
| tMCHDV | Data Enabled on TS Entry | 0 < CLOAD < 100 pF | 0 | — | 60 | ns |
| tMCHDV1 | Data Delay from MC | 0 < CLOAD < 100 pF | 0 | — | 60 | ns |
| tMCLDZ* | Data Float on TS Exit | CLOAD = 0 | 15 | — | 100 | ns |
| tFSHMCL | Frame-sync Hold Time | — | 50 | — | — | ns |
| tMCLFSH | Frame-sync High Setup | — | 50 | — | — | ns |
| tFSLMCL | Frame-sync Low Setup | — | 50 | — | — | ns |
| tFSHFSL | Frame-sync Pulse Width | — | 0.1 | — | 125 – tMCHMCH | μs |

* Timing parameter tMCLDZ is referenced to a high-impedance state.

Table 16. T5504 Transmit Section (See Figure 8.)

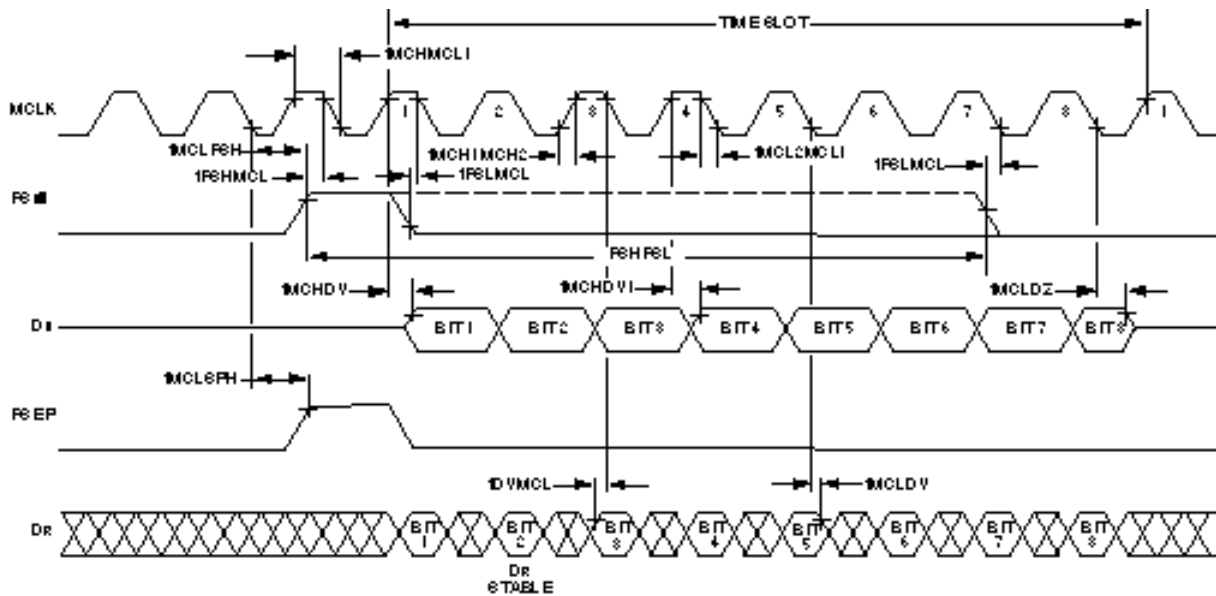
| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|---------|--------------------------|--------------------|-----|-----|---------------|------|
| tFSDV | Data Enabled on TS Entry | 0 < CLOAD < 100 pF | 0 | — | 80 | ns |
| tMCHDV1 | Data Delay from FSX | 0 < CLOAD < 100 pF | 0 | — | 60 | ns |
| tMCHDZ* | Data Float on TS Exit | CLOAD = 0 | 0 | — | 30 | ns |
| tFSHMCL | Frame-sync Hold Time | — | 50 | — | — | ns |
| tMCLFSH | Frame-sync High Setup | — | 50 | — | — | ns |
| tFSLMCL | Frame-sync Low Setup | — | 50 | — | — | ns |
| tFSHFSL | Frame-sync Pulse Width | — | 0.1 | — | 125 – tMCHMCH | μs |

* Timing parameter tMCHDZ is referenced to a high-impedance state.

Timing Characteristics (continued)

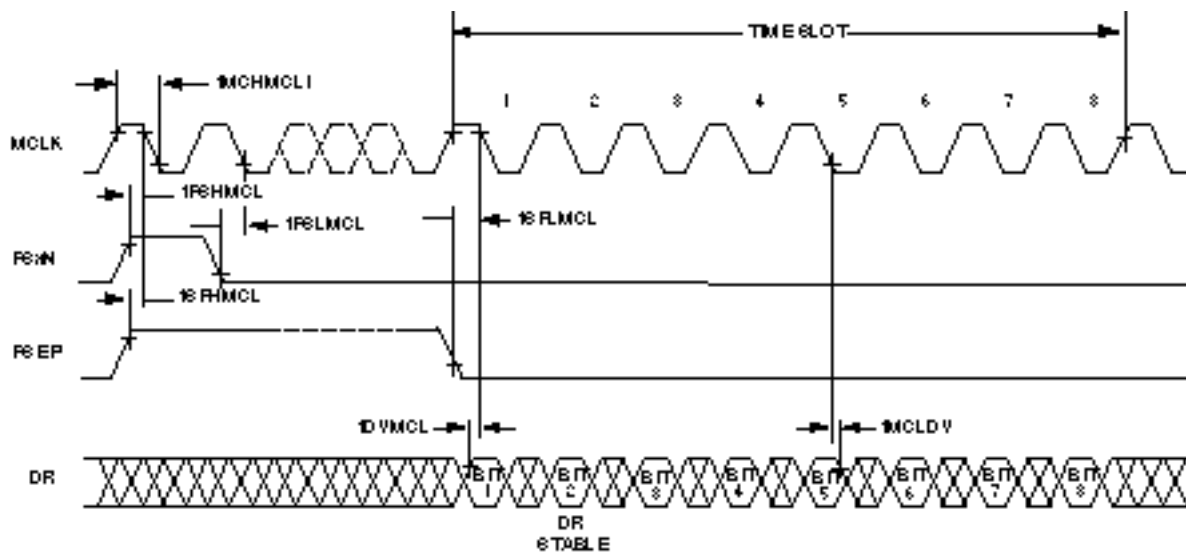
Table 17. T7504 and T5504 Receive Section (See Figures 6, 7, 8, and 9.)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|---------|-----------------------------|-----------------|-----|-----|-----|------|
| tDVMCL | Receive Data Setup | — | 30 | — | — | ns |
| tMCLDV | Receive Data Hold | — | 15 | — | — | ns |
| tSPHMCL | Frame Separation Hold Time | — | 50 | — | — | ns |
| tMCLSPH | Frame Separation High Setup | — | 50 | — | — | ns |
| tSPLMCL | Frame Separation Low Setup | — | 50 | — | — | ns |



5-3581 (C)

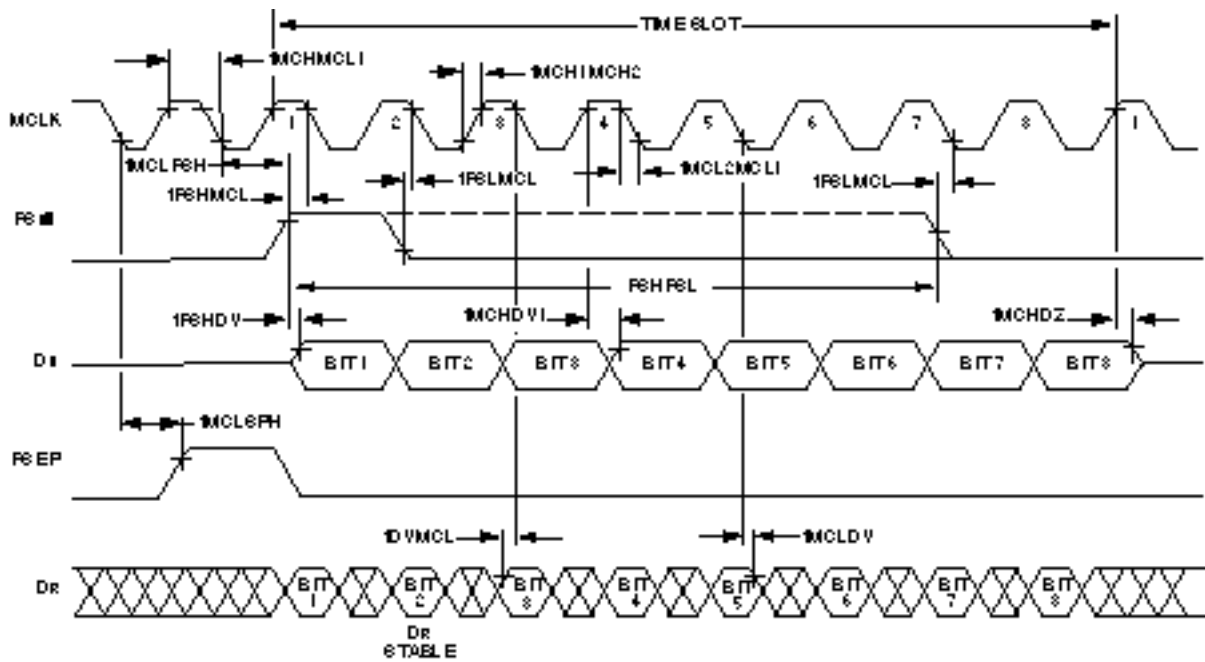
Figure 6. T7504 Transmit and Receive Timing, FSEP = 1 MCLK



5-3582 (C)

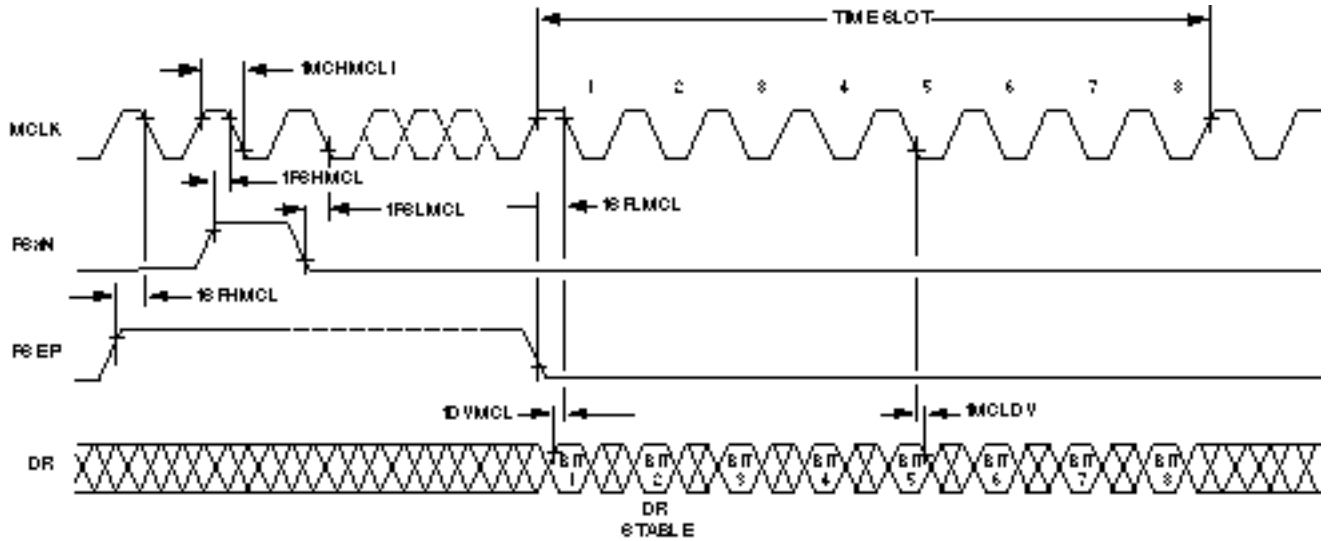
Figure 7. T7504 Receive Timing, FSEP > 1 MCLK

Timing Characteristics (continued)



5-3581 (C).a

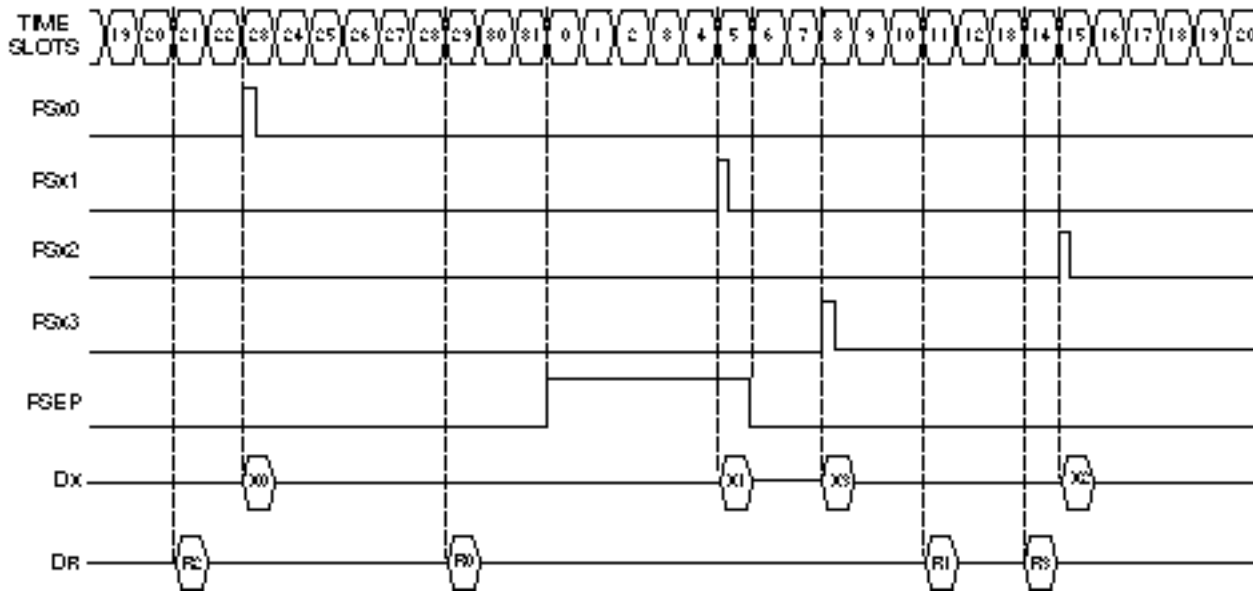
Figure 8. T5504 Transmit and Receive Timing, FSEP = 1 MCLK



5-3582 (C).a

Figure 9. T5504 Receive Timing, FSEP > 1 MCLK

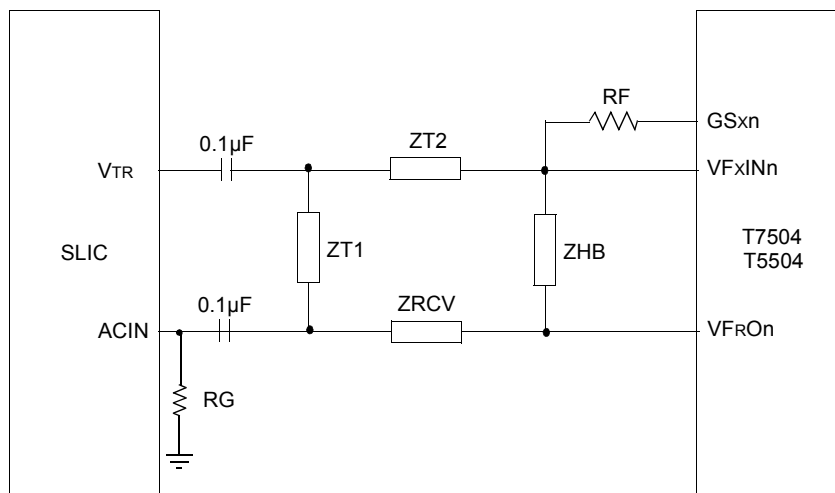
Timing Characteristics (continued)



5-3583 (C).a

Figure 10. Typical Frame Sync Timing (2 MHz Operation)

Applications



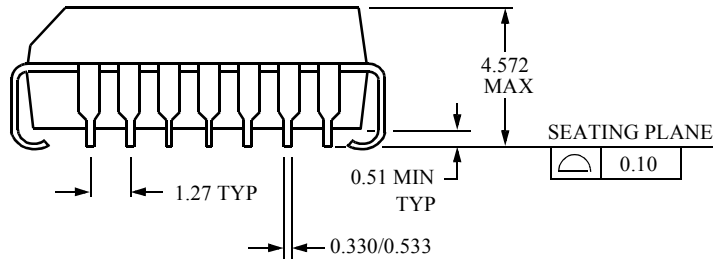
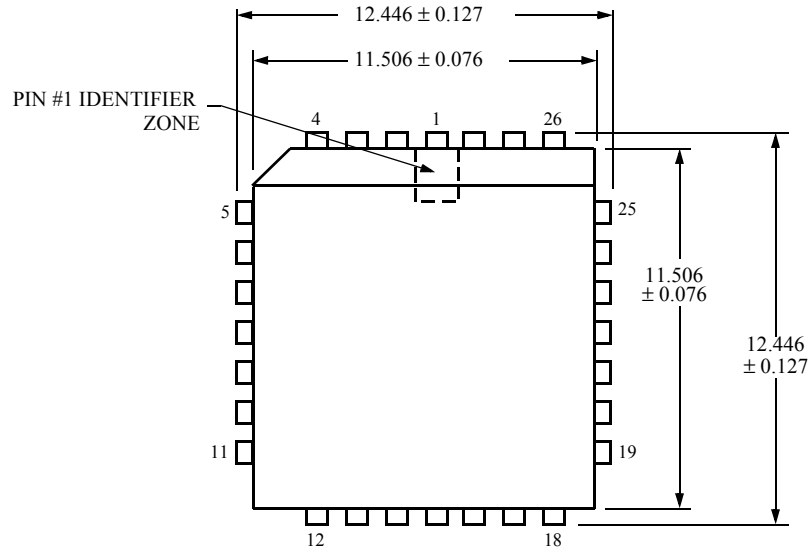
5-3584 (F)

Figure 11. Typical T7504 and T5504/SLIC Interconnection

Outline Diagrams

28-Pin PLCC

Controlling dimensions are in inches.

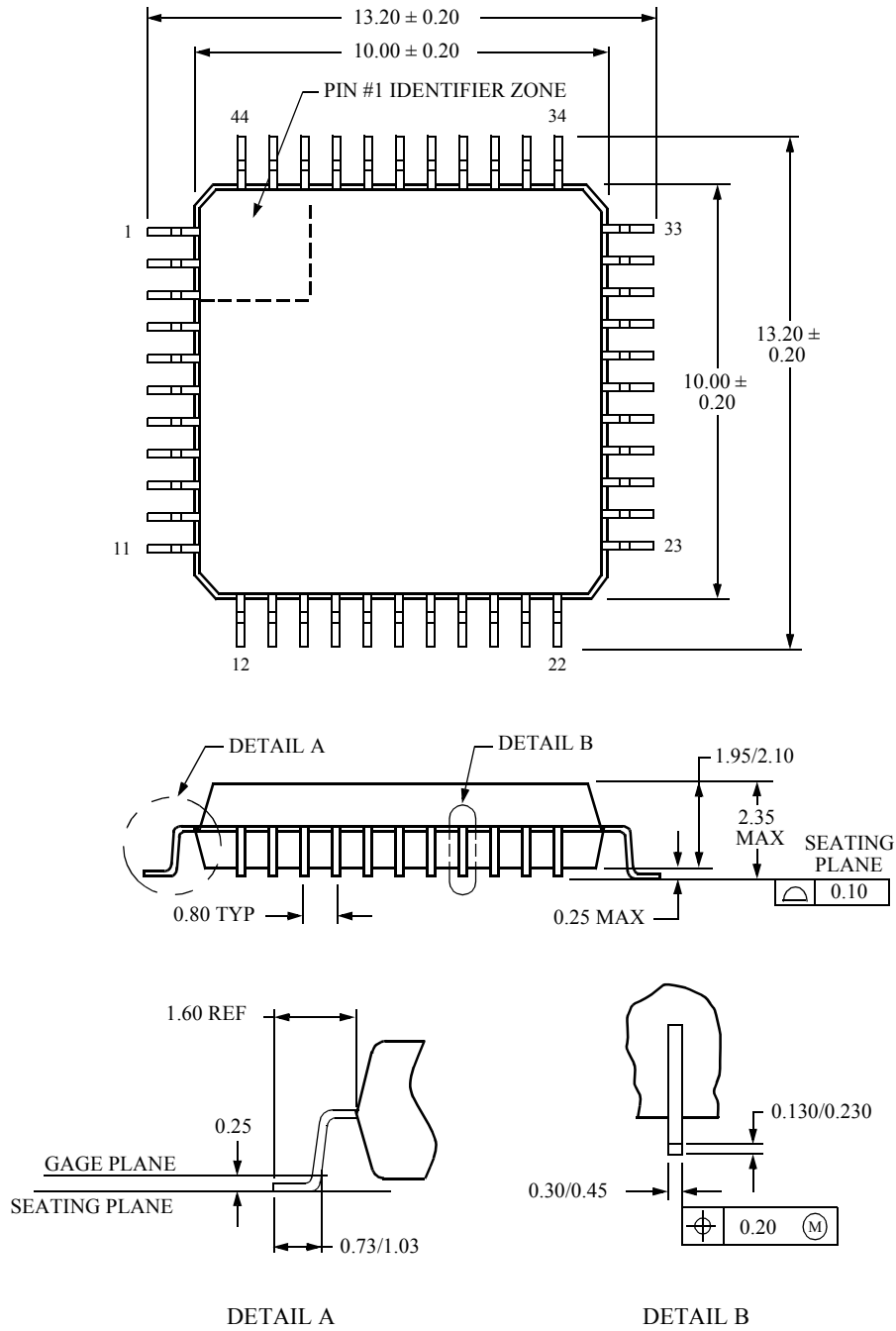


5-2608 (F).r5

Outline Diagrams (continued)

44-Pin MQFP

Controlling dimensions are in inches.



5-2111 (F).r12

Ordering Information

| Device Code | Package | Temperature | Timing Mode | Comcode |
|----------------------|-------------------------------|------------------|-------------|-----------|
| T - 7504 - - - ML | 28-Pin, PLCC | -40 °C to +85 °C | Delayed | 107203184 |
| T - 7504 - - - JL-DB | 44-Pin, MQFP Dry Pack Tray | -40 °C to +85 °C | Delayed | 107740466 |
| T - 7504 - - - ML-TR | 28-Pin, PLCC Tape and Reel | -40 °C to +85 °C | Delayed | 107231680 |
| T - 5504 - - - ML | 28-Pin, PLCC | -40 °C to +85 °C | Nondelayed | 107364044 |
| T - 5504 - - - ML-TR | 28-Pin, PLCC Tape and Reel | -40 °C to +85 °C | Nondelayed | 107364051 |

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